

Field Effect Transistor

Silicon N Channel MOS Type (π -MOS II)

High Speed, High Current DC-DC Converter,

Relay Drive and Motor Drive Applications

Features

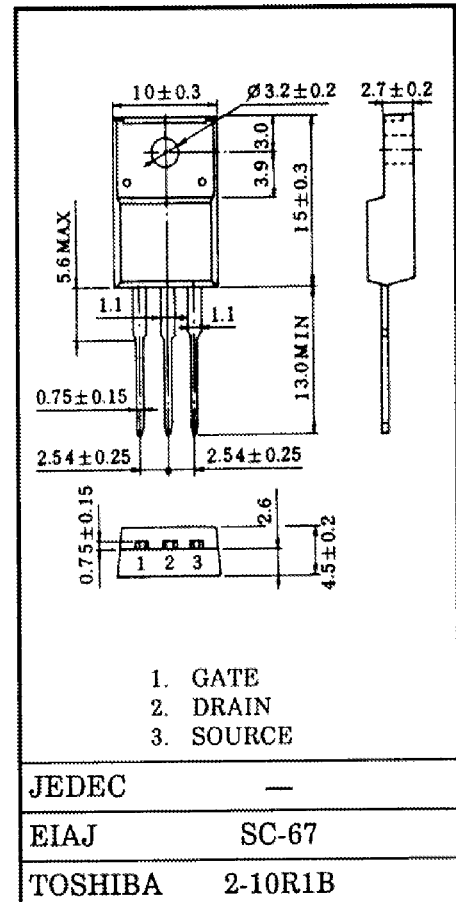
- High Voltage
 - $V_{(BR)DSS} = 900V$
- High Forward Transfer Admittance
 - $|Y_{fs}| = 1.0S$ (Typ.) @ $I_D = 1.5A$
- Low Leakage Current
 - $I_{DSS} = 300\mu A$ (Max.) @ $V_{DS} = 900V$
- Enhancement-Mode

Absolute Maximum Ratings ($T_a = 25^\circ C$)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DSS}	900	V
Gate-Source Voltage	V_{GSS}	± 30	V
Drain Current	DC	I_D	3
	Pulse	I_{DP}	5
Drain Power Dissipation ($T_c = 25^\circ C$)	P_D	40	W
Channel Temperature	T_{ch}	150	$^\circ C$
Storage Temperature Range	T_{stg}	-55 ~ 150	$^\circ C$

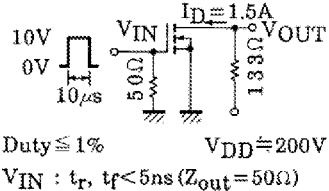
This transistor is an electrostatic sensitive device. Please handle with care.

Industrial Applications Unit in mm



Weight : 1.9g

Electrical Characteristics (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		I_{GSS}	$V_{GS} = \pm 25V, V_{DS} = 0V$	-	-	± 100	nA
Drain Cut-off Current		I_{DSS}	$V_{DS} = 900V, V_{GS} = 0V$	-	-	300	μA
Drain-Source Breakdown Voltage		$V_{(BR)DSS}$	$I_D = 10mA, V_{GS} = 0V$	900	-	-	V
Gate Threshold Voltage		V_{th}	$V_{DS} = 10V, I_D = 1mA$	1.5	-	3.5	V
Drain-Source Resistance		$R_{DS(ON)}$	$I_D = 1.5A, V_{GS} = 10V,$	-	3.3	4.3	Ω
Forward Transfer Admittance		$ Y_{fs} $	$V_{DS} = 10V, I_D = 1.5A$	0.5	1.0	-	S
Input Capacitance		C_{iss}	$V_{DS} = 25V, V_{GS} = 0V,$ $f = 1MHz$	-	800	1100	pF
Reverse Transfer Capacitance		C_{rss}		-	70	120	
Output Capacitance		C_{oss}		-	120	200	
Switching Time	Rise Time	t_r	 <p>Duty $\leq 1\%$ $V_{DD} = 200V$ $V_{IN} : t_r, t_f < 5ns (Z_{out} = 50\Omega)$</p>	-	55	120	ns
	Turn-on Time	t_{on}		-	70	165	
	Fall Time	t_f		-	60	120	
	Turn-off Time	t_{off}		-	280	550	

